## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## PROCESS OF FABRICATING CONDUCTIVE COLUMN AND CIRCUIT BOARD WITH CONDUCTIVE COLUMN

the s	specification of w	hich			
_X 	is attached hereto.  was filed on as Application Serial No and was amended on				
appli forei any appli	ification, includir I acknowledge ication in accord I hereby claim gn application(s foreign applicati	ng the claims, as amend the duty to disclose intance with Title 37, Code foreign priority benefith for patent or inventors ion for patent or inventors priority is claimed:	and understood the contended by any amendment referr formation which is material to e of Federal Regulations, § 1 ts under Title 35, United Sta s certificate listed below and tor's certificate having a filin	ed to above. the patental 56(a). ates Code, § have also ide	bility of this 119 of any ntified below
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
	93122358	Taiwan, R.O.C.	2004/7/27	X	
	•	in the Patent and Trade	•		ation and to

SEND CORRESPONDENCE TO:

DIRECT TELEPHONE CALLS TO: (Name and Telephone Number)

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## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature: Dand O.H. Char

Sept. 27, 2004

Sole or First Joint Inventor: David C. H. Cheng

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